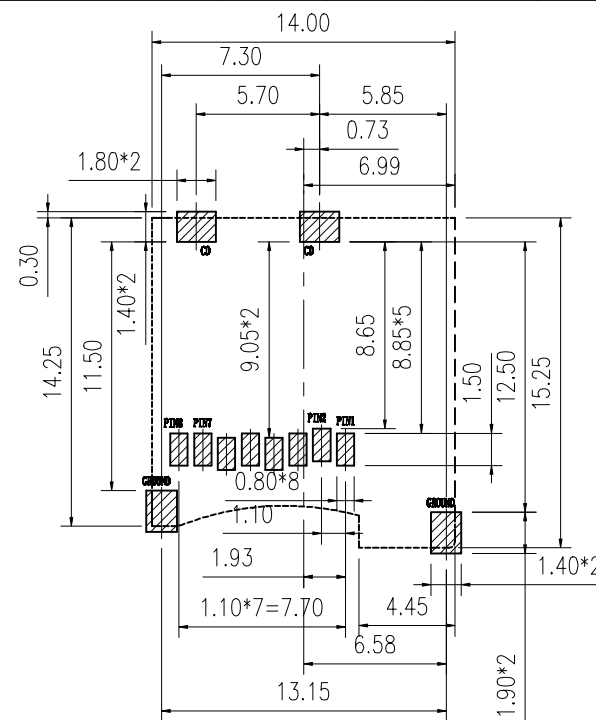
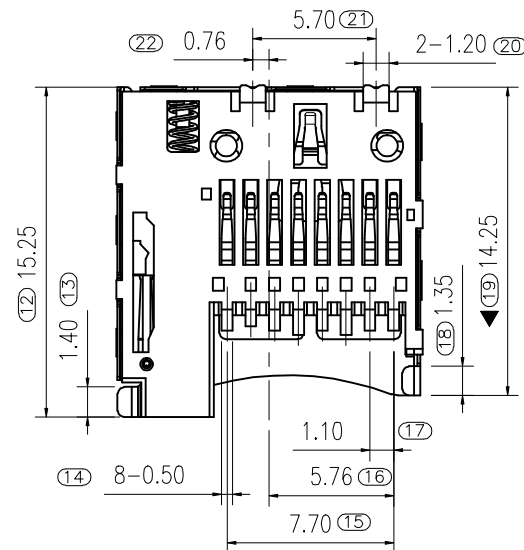
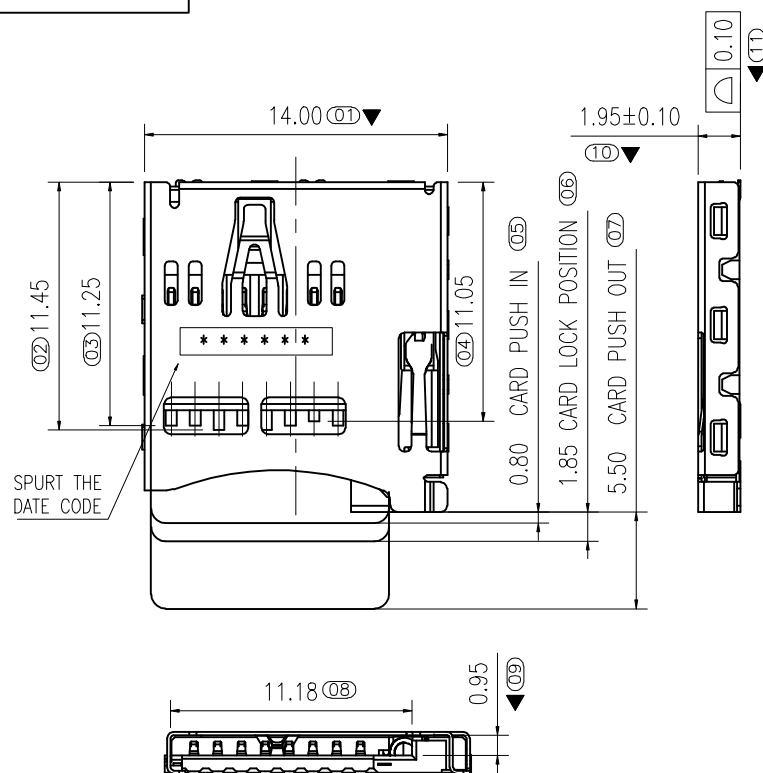


RoHS

REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A0		NEW RELEASE	10/06'20	TEDDY	/	SUNNLY



RECOMMEND PCB LAYOUT
GENERAL TOLERANCE ± 0.05

NOTES:

1. MATERIAL:

1.1 Housing: High Temperature Thermoplastic
UL94V-0; Color Black.

1.2 Terminal: Copper Alloy.

1.3 Shell: Stainless Steel.

2. PLATING:

2.1 Contact: Contact Area: Au G/F, Solder area: Matte tin
80u"Min ; Under plate Ni 40u"Min all over

2.2 SHELL: Solder Area: Au G/F, Under plate Ni 50u"Min all over

2.3 CD PIN: Contact Area: Au G/F, Under plate Ni 50u"Min all over

3. SPECIALITY:

3.1 Rated current: 1.0A

3.2 Rated voltage: 30V

3.3 Contact Resistance: 50mΩ MAX

3.4 Insulation Resistance: 1000MΩ MIN 500V DC

3.5 Dielectric withstanding voltage: 500V AC.

3.6 Solder ability: 255±5℃, 5±0.5s.

3.7 Durability: 10000 Cycles Min.

3.8 Operating condition: Temperature -40℃~+85℃;
Humidity 80% R.H MAX

Pin No.	MICRO SD
PIN1	DAT2 1P
PIN2	CD/DAT3 2P
PIN3	CMD 3P
PIN4	VDD 4P
PIN5	CLK 5P
PIN6	VSS 6P
PIN7	DAT0 7P
PIN8	DAT1 8P
PIN9	CARD DETECT
PIN10	

DATE CODE 日期: ****

日: 01表示1号
.....
07表示7号
月: 01表示一月
.....
12表示十二月
年: 10表示2010年

开关插卡状态

CIRCUIT:	CD	GROUND	CD	GROUND
WITHOUT CARD	○	○	○	○
CARD INSERTED	○	○	○	○

Seconn International Enterprise Co., Ltd.

TOLERANCES			PROJECTION	TITLE		
x.	= ±	----	UNIT mm	TF / Micro SD Card Connector Push Push H: 1.85mm Type with Detect Switch (Normally Closed Type)		
x.x	= ±	0.30				
x.xx	= ±	0.20				
x.xxx	= ±	0.10				
DRAWN	TEDDY	DATE	2020/10/06	PART NO.	MCSD-S102014462	
SCALE	1:1	SIZE	A4	SHEET	1/1	REV A0